Surface Mountable PTC Resettable Fuse



Specifications:

Applications : All high-density boards.

Product features : Small surface mountable, solid state, faster time to trip than

standard SMD devices, lower resistance than standard SMD devices.

Maximum voltage : 6V to 15V.
Temperature range : -40°C to 85°C.

UL: E-345437



RoHS Compliant

Electrical Characteristics (23°C)

Hold	Trip	Rated	Rated Maximum Typical Maximum		Maximum 1	ime to Trip	Resis	stance	
Current	Current	Voltage	Current	Power	Current	Time	R _{Min}	R1 _{Max}	Part Number
I _{H,} A	I _{T,} A	V _{Max,} V dc	I _{Max,} A	P _d , W	Amperes	Seconds	Ω	Ω	
0.20	0.50	9	100	0.5	8.00	0.02	0.400	3.500	MC36206
0.35	0.75	6	100	0.5	8.00	0.10	0.250	1.200	MC36210
0.50	1.00	6	100	0.5	8.00	0.10	0.150	0.850	MC36213
0.75	1.50	6	40	0.6	8.00	0.20	0.090	0.350	MC36215
1.00	1.95	6	40	0.6	8.00	0.30	0.060	0.210	MC36220

I_H = Hold current-maximum current at which the device will not trip at 23°C still air.

I_T = Trip current-minimum current at which the device will always trip at 23°C still air.

V_{MAX} = Maximum voltage device can withstand without damage at it rated current (I maximum).

I_{MAX} = Maximum fault current device can withstand without damage at rated voltage (V maximum).

P_d = Typical power dissipated-type amount of power dissipated by the device when in the tripped state in 23°C still air environment.

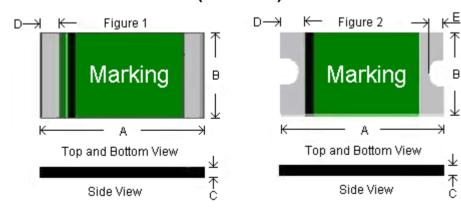
 R_{MIN} = Minimum device resistance at 23°C prior to tripping.

R1_{MAX} = Maximum device resistance at 23°C measured 1 hour after tripping or reflow soldering of 260°C for 20 seconds.

Termination pad characteristics

Termination pad materials: Pure tin.

Production Dimensions (Millimeter)



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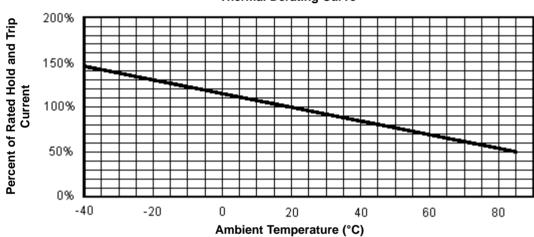
Dimensions: Millimetres

Dimensions Table

A		В		С		D		E		Figure	Part Number
Minimum	Maximum		rait Number								
2.00	2.30	1.20	1.50	0.55	1.00	0.20	0.60			1	MC36206
2.00	2.30	1.20	1.50	0.45	0.75	0.20	0.60			1	MC36210
2.00	2.20	1.20	1.50	0.55	1.25	0.20	0.60	0.10	0.45	2	MC36213
2.00	2.20	1.20	1.50	0.55	1.25	0.20	0.60	0.10	0.45	2	MC36215
2.00	2.20	1.20	1.50	0.75	1.80	0.20	0.60	0.10	0.45	2	MC36220

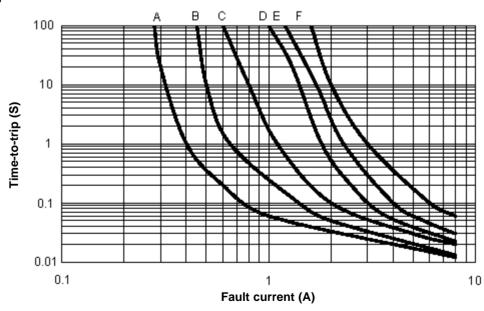
Thermal Derating Curve

Thermal Derating Curve



Typical Time-To-Trip at 23°C

B = MC36206 C = MC36210 D = MC36213 E = MC36215 F = MC36220



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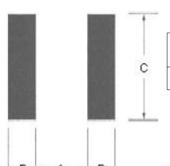
Material Specification

Terminal pad material : Pure tin.

Soldering characteristics : Meets EIA specification RS 186-9E, ANSI/J-std-002 category 3.

Pad Layouts Solder Reflow and Rework Recommendations

The dimension in the table below provide the recommended pad layout for each 0805 device.



Pad Dimensions

Device A		B	C	
Nominal		Nominal	Nominal	
All 0805 Series	1.20	1.00	1.50	

Dimensions: Millimetres

Profile Feature	Pb-Free Assembly		
Average Ramp-Up Rate (T _s maximum to T _p)	3°C/second maximum		
Preheat: Temperature Minimum (T _s minimum) Temperature Maximum (T _s maximum) Time (t _s minimum to t _s maximum)	150°C 200°C 60-180 seconds		
Time maintained above: Temperature (T _L) Time (t _L)	217°C 60-150 seconds		
Peak/Classification Temperature (T _p):	260°C		
Time within 5°C of actual Peak: Temperature (t _p)	20-40 seconds		
Ramp-Down Rate:	6°C/second maximum		
Time 25°C to Peak Temperature:	8 minutes maximum		

Note 1: All temperatures refer to of the package, measured on the package body surface.

Solder reflow

Due to "Lead Free" nature, Temperature and Dwelling time for the soldering zone is higher than those for Regular. This may cause damage to other components.

- 1. Recommended max past thickness > 0.25mm.
- 2. Devices can be cleaned using standard methods and aqueous solvent.
- 3. Rework use standard industry practices.
- 4. Storage Environment : < 30°C/60% RH.

Caution:

- 1. If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- 2. Devices are not designed to be wave soldered to the bottom side of the board.

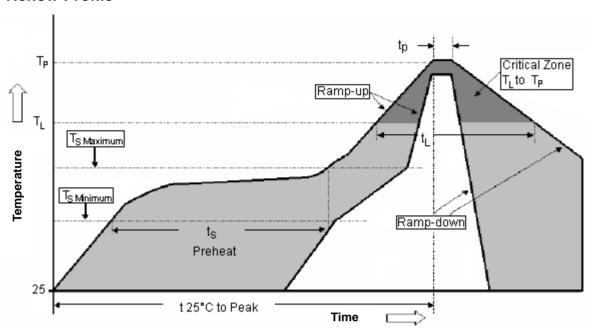
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Reflow Profile



Part Number Table

Description	Part Number
Surface Mountable PTC Resettable Fuse	MC36206
Surface Mountable PTC Resettable Fuse	MC36210
Surface Mountable PTC Resettable Fuse	MC36213
Surface Mountable PTC Resettable Fuse	MC36215
Surface Mountable PTC Resettable Fuse	MC36220

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